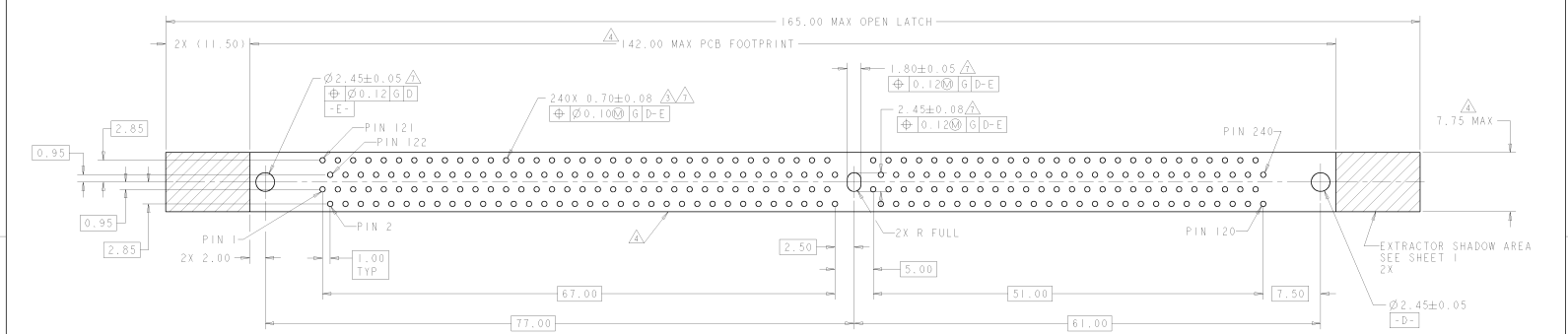


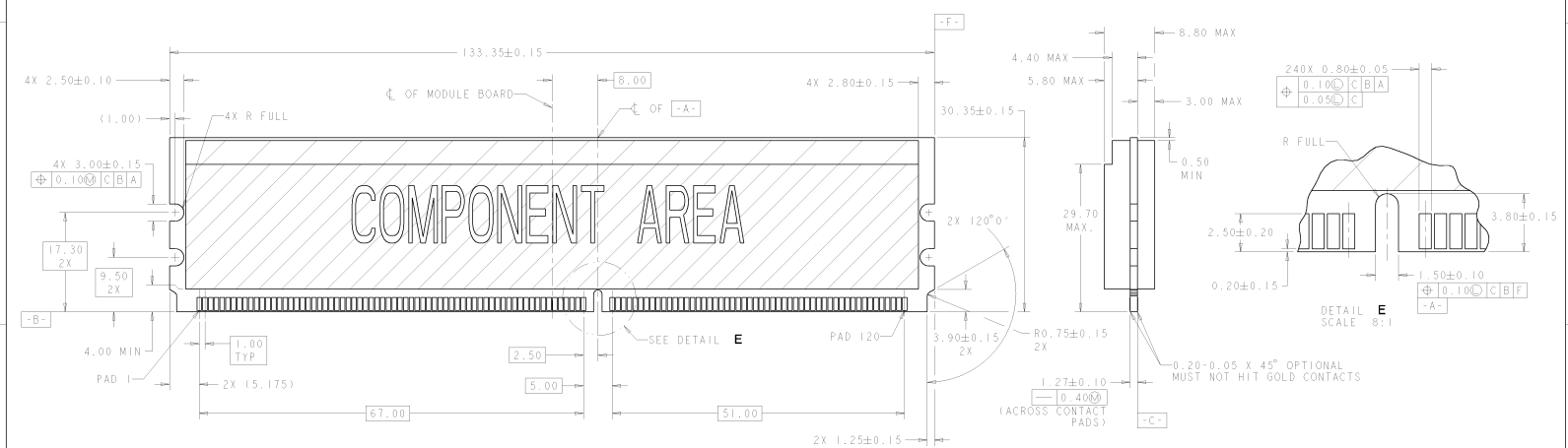


8	7	6	5	4	3	2	1
DATE: 01/10/2018	REVISED FOR PUBLICATION						
BY: TONY ELECTRONICS CORPORATION, 11110011 REVISED							

REV	DATE	DESCRIPTION	BY	CHK	APPV
00	ES	SEE SHEET 1			



RECOMMENDED PCB LAYOUT  
VIEWED FROM CONNECTOR SIDE



RECOMMENDED MODULE LAYOUT  
SCALE 3:1  
NOTE: REFER TO JEDEC MO-256 FOR COMPLETE MODULE DETAILS

TYPHO ELECTRONICS 11110011 REVISED		TYPHO ELECTRONICS 11110011 REVISED		TYPHO ELECTRONICS 11110011 REVISED	
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CUSTOMER DRAWING:			SOCKET ASSEMBLY VERTICAL FB DIMM SOLDER TAIL - 240 POSITION		